

High Power LED Series
Chip on Board

Vivid Color COB D – Gen2



High efficacy COB LED package,
well-suited for use in spotlight applications

Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs



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1. Characteristics

a) Absolute Maximum Rating

Item	Symbol	Model	Rating	Unit	Condition
Ambient / Operating Temperature	T _a	-	-40 ~ +105	°C	-
Storage Temperature	T _{stg}	-	-40 ~ +120	°C	-
LED Junction Temperature	T _J	-	130	°C	-
Case Temperature	T _c	-	115	°C	-
Forward Current / Power Dissipation	I _F / P _D	LC013D	920 / 34.5	mA / W	-
		LC016D	1150 / 43.1		-
		LC019D	1380 / 51.8		-
		LC026D	1840 / 69		-
		LC033D	2300 / 86		-
ESD (HBM)	-		±2	kV	-
ESD (MM)	-		±0.5	kV	-

b) Electro-optical Characteristics (I_F = Sorting Current, T_J = 85°C)

Item	Unit	Model	Rank	Min.	Typ.	Max.
Forward Voltage (V _F)	V	LC013D	YH	31.8	34.6	37.5
		LC016D	YH	31.8	34.6	37.5
		LC019D	YH	31.8	34.6	37.5
		LC026D	YH	31.8	34.6	37.5
		LC033D	YH	31.8	34.6	37.5
Thermal Resistance (junction to case point)	°C/W	LC013D	-	-	1.27	-
		LC016D	-	-	1.01	-
		LC019D	-	-	0.9	-
		LC026D	-	-	0.71	-
		LC033D	-	-	0.6	-
Beam Angle	°	All Model		-	115	-
Nominal Power (Sorting Current)	W (mA)	LC013D	-	-	12.5 (360)	-
		LC016D	-	-	15.6 (450)	-
		LC019D	-	-	18.7 (540)	-
		LC026D	-	-	24.9 (720)	-
		LC033D	-	-	31.1 (900)	-

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature (T_J = T_C = 85 °C)
- 2) Samsung maintains measurement tolerance of: forward voltage = ±5 %, CRI = ±1
Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range.

c) Luminous Flux Characteristics (I_F = Sorting Current)

Model	Nominal CCT (K)	Flux Rank	$T_c = 85\text{ }^\circ\text{C}$ (lm)		$T_c = 25\text{ }^\circ\text{C}$ (lm)	
			Min.	Typ.	Min.	Typ.
LC013D	3000	D2	1241	1334	1478	1590
	3300	D2	1296	1394	1545	1661
	3500	D2	1333	1433	1588	1708
	4000	D2	1425	1533	1699	1827
LC016D	3000	D2	1623	1745	1934	2080
	3300	D2	1695	1823	2021	2173
	3500	D2	1744	1875	2078	2235
	4000	D2	1864	2005	2222	2390
LC019D	3000	D2	1923	2068	2292	2465
	3300	D2	2009	2160	2395	2575
	3500	D2	2066	2222	2463	2648
	4000	D2	2210	2376	2634	2832
LC026D	3000	D2	2516	2706	2999	3225
	3300	D2	2629	2827	3133	3369
	3500	D2	2704	2907	3222	3465
	4000	D2	2891	3108	3446	3705
LC033D	3000	D2	3105	3339	3701	3980
	3300	D2	3244	3488	3867	4158
	3500	D2	3337	3588	3977	4276
	4000	D2	3568	3836	4252	4572

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_c = 85\text{ }^\circ\text{C}$).
- 2) Samsung maintains measurement tolerance of: Luminous flux = $\pm 7\%$, CRI = ± 1

2. Product Code Information

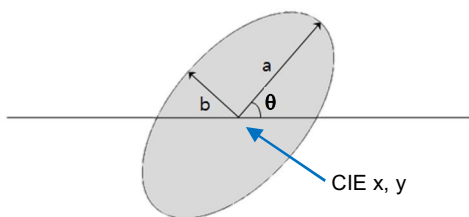
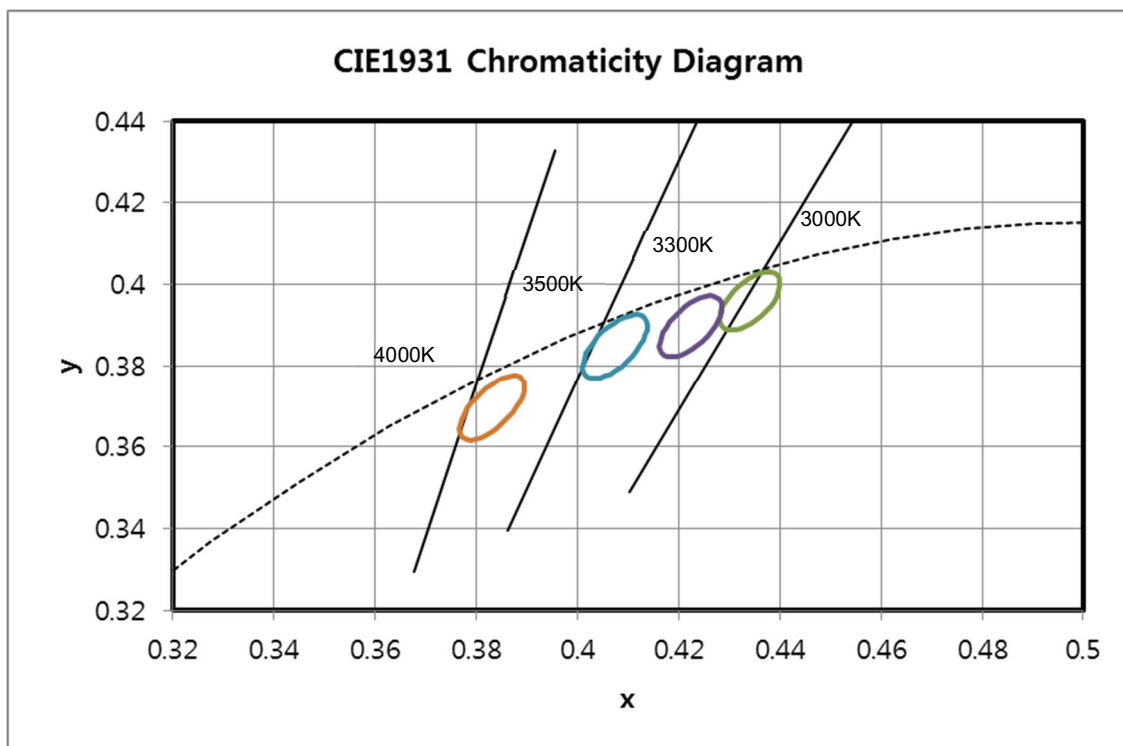
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	H	W	H	A	H	D	N	G	2	V	Y	Z	V	V	D	2

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WH	Warm White (T/U/V/W Ranks)
6	Product Version	A	
7 8	Form Factor	HD	COB
9	Lens Type	N	No lens
10	Internal Code	D E F G H	LC013 LC016 LC019 LC026 LC033
11	Internal Code	2	
12	CRI & Sorting Temperature	V	VIVID 85 °C
13 14	Forward Voltage (V)	YZ	31.8~37.5
15	CCT (K)	V A U T	3000 K 3300 K 3500 K 4000 K
16	MacAdam	V	Color Bin for Vivid product
17 18	Luminous Flux	D2	COB D-series Gen.2 level

a) Binning Structure (I_F = Sorting Current, T_J =85 °C)

Model	Nominal CCT (K)	Product Code	V_F Rank	Color Rank	Flux Rank	Flux Range (Φ_v , lm)
LC013D	3000	SPHWAHDND2VYZVVD2	YZ	VV	D2	1241~
	3300	SPHWAHDND2VYZAVD2	YZ	AV	D2	1296~
	3500	SPHWAHDND2VYZUVD2	YZ	UV	D2	1333~
	4000	SPHWAHDND2VYZTVD2	YZ	TV	D2	1425~
LC016D	3000	SPHWAHDNE2VYZVVD2	YZ	VV	D2	1623~
	3300	SPHWAHDNE2VYZAVD2	YZ	AV	D2	1695~
	3500	SPHWAHDNE2VYZUVD2	YZ	UV	D2	1744~
	4000	SPHWAHDNE2VYZTVD2	YZ	TV	D2	1864~
LC019D	3000	SPHWAHDNF2VYZVVD2	YZ	VV	D2	1923~
	3300	SPHWAHDNF2VYZAVD2	YZ	AV	D2	2009~
	3500	SPHWAHDNF2VYZUVD2	YZ	UV	D2	2066~
	4000	SPHWAHDNF2VYZTVD2	YZ	TV	D2	2210~
LC026D	3000	SPHWAHDNG2VYZVVD2	YZ	VV	D2	2516~
	3300	SPHWAHDNG2VYZAVD2	YZ	AV	D2	2629~
	3500	SPHWAHDNG2VYZUVD2	YZ	UV	D2	2704~
	4000	SPHWAHDNG2VYZTVD2	YZ	TV	D2	2891~
LC033D	3000	SPHWAHDNH2VYZVVD2	YZ	VV	D2	3105~
	3300	SPHWAHDNH2VYZAVD2	YZ	AV	D2	3244~
	3500	SPHWAHDNH2VYZUVD2	YZ	UV	D2	3337~
	4000	SPHWAHDNH2VYZTVD2	YZ	TV	D2	3568~

b) Chromaticity Region & Coordinates (I_F = Sorting Current, T_J = 85 °C)



MacAdam Ellipse (3000K, VV)					
Step	CIE x	CIE y	θ	a	b
3-step	0.4341	0.3959	53.22	0.0083	0.0041

MacAdam Ellipse (3300K, AV)					
Step	CIE x	CIE y	θ	a	b
3-step	0.4033	0.3813	54	0.0093	0.0042

MacAdam Ellipse (3500K, UV)					
Step	CIE x	CIE y	θ	a	b
3-step	0.3785	0.3677	53.72	0.0093	0.0039

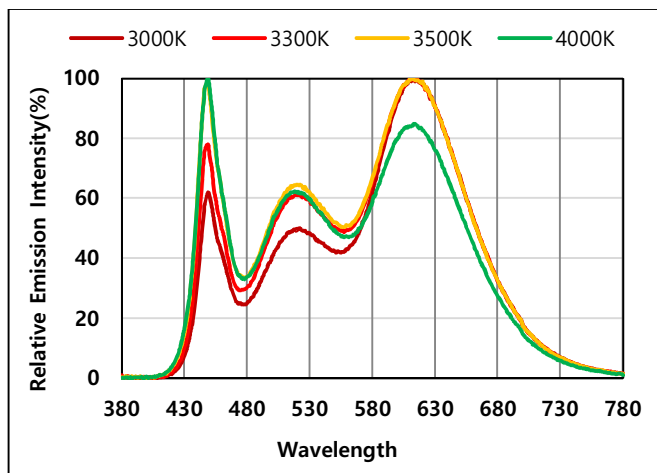
MacAdam Ellipse (4000K, TV)					
Step	CIE x	CIE y	θ	a	b
3-step	0.4033	0.3813	54	0.0093	0.0042

Note:

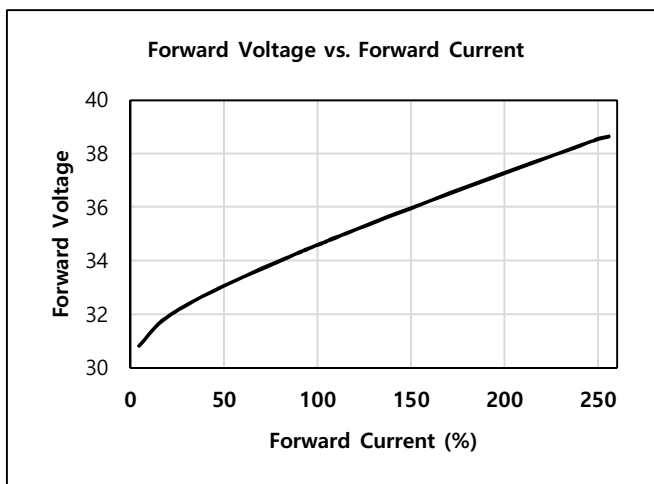
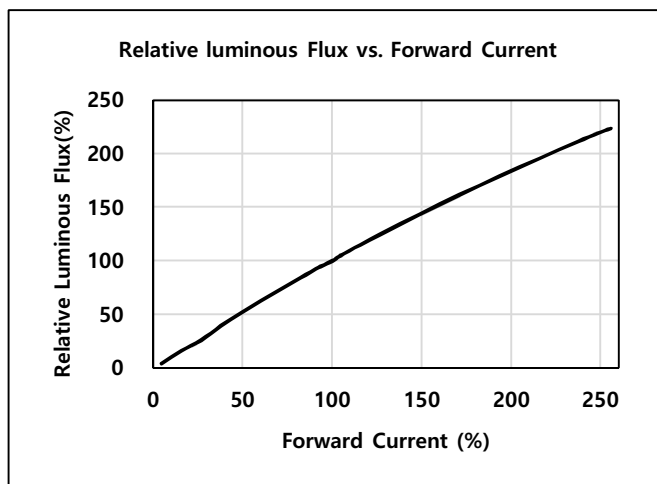
Samsung maintains measurement tolerance of: $C_x, C_y = \pm 0.005$

3. Typical Characteristics Graphs

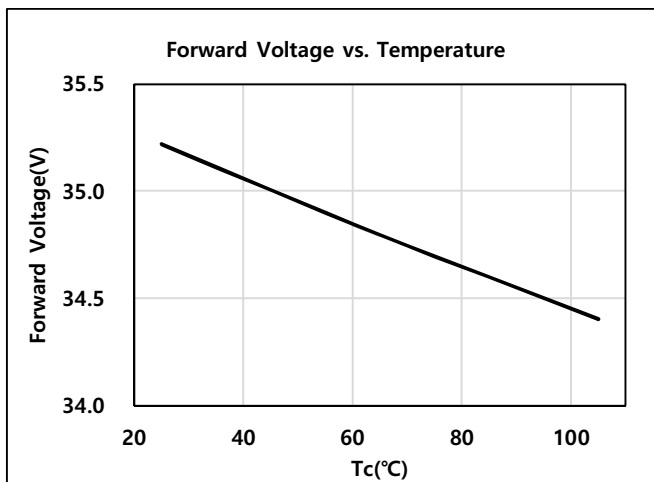
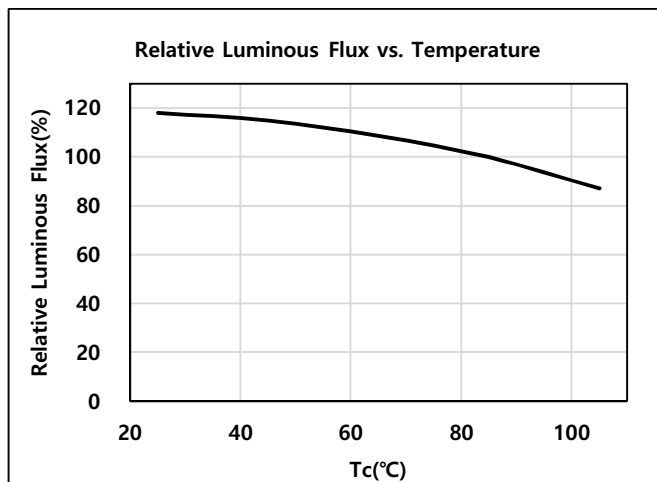
a) Spectrum Distribution (I_f = Sorting Current, $T_j = 85^\circ\text{C}$)



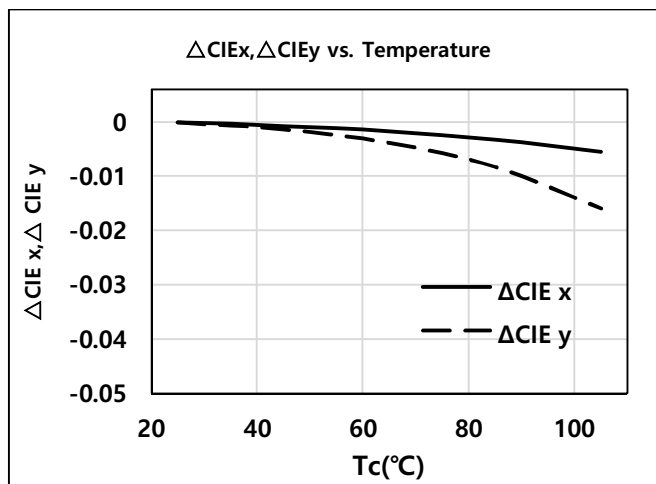
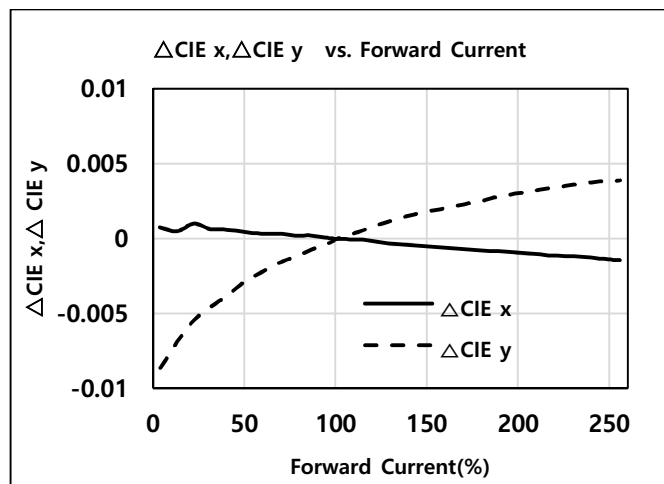
b) Forward Current Characteristics ($T_j = 85^\circ\text{C}$)



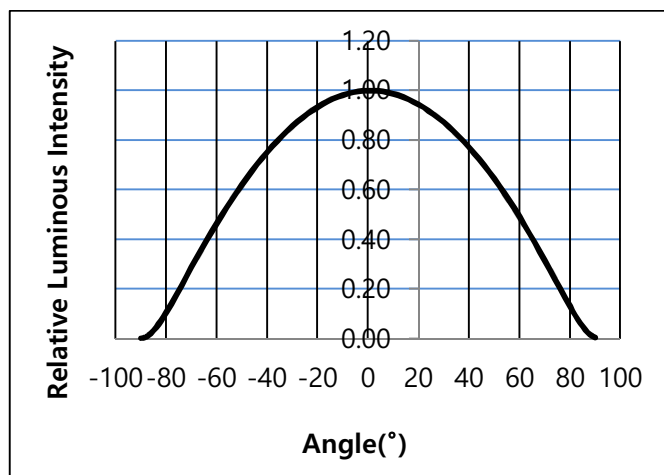
c) Temperature Characteristics (I_f = Sorting Current)



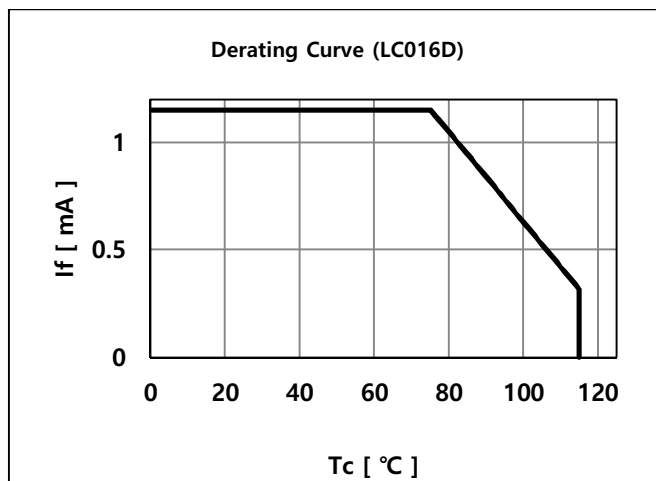
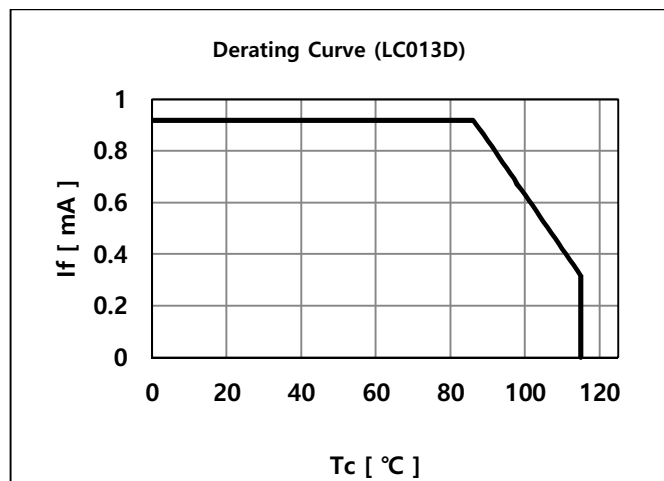
d) Color Shift Characteristics (I_F = Sorting Current, $T_J = 85^\circ\text{C}$)

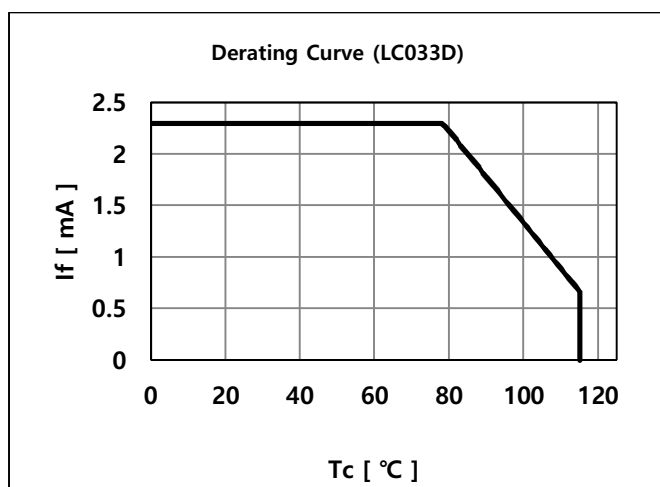
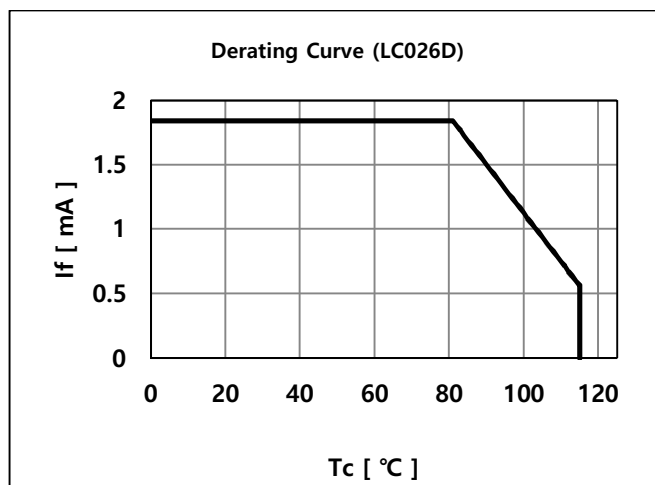
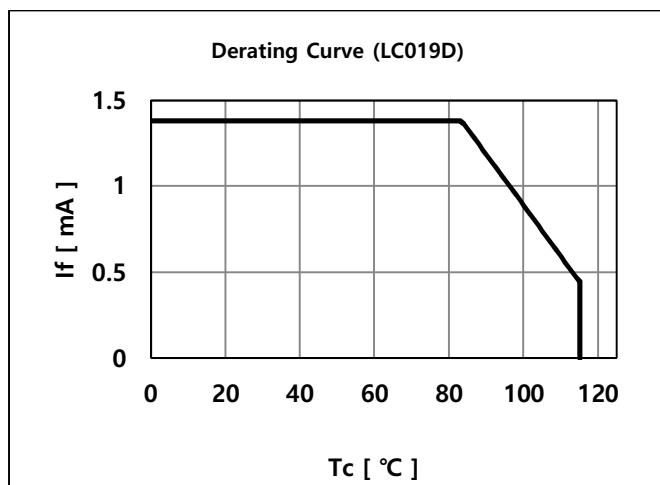


e) Beam Angle Characteristics (I_F = Sorting Current, $T_J = 85^\circ\text{C}$)



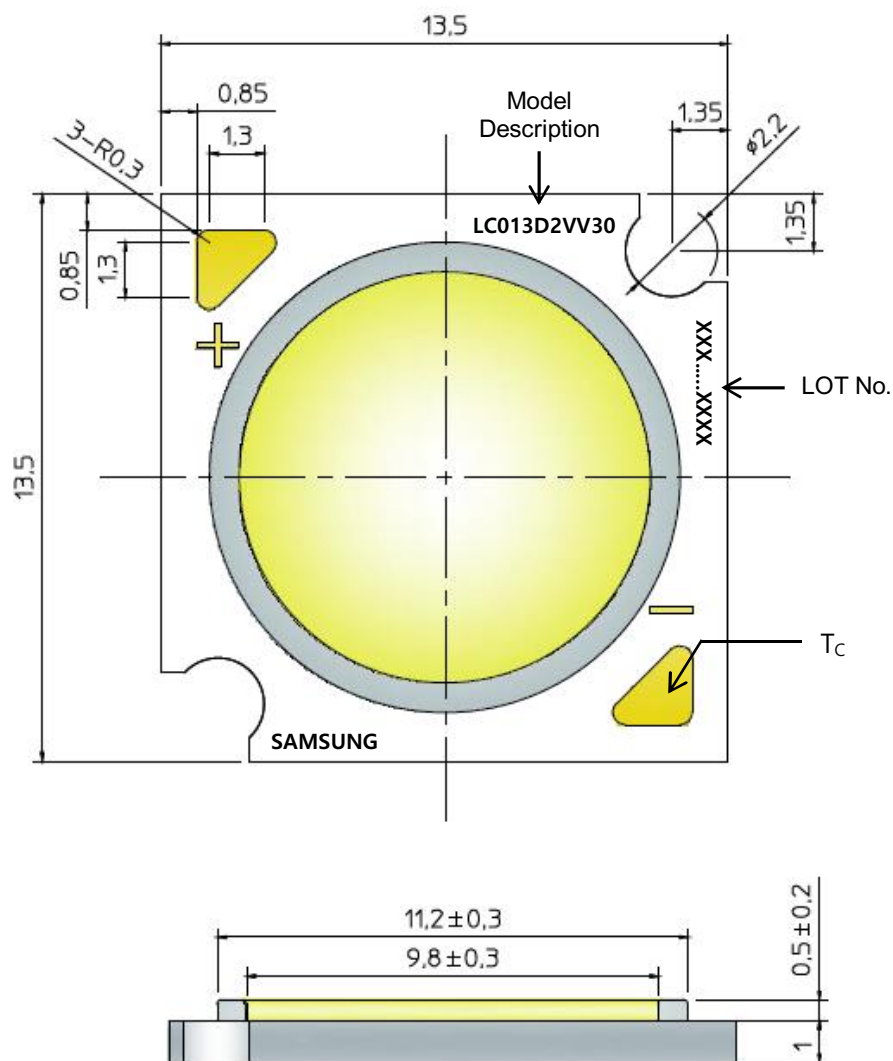
f) Derating Characteristics





4. Outline Drawing & Dimension

※ Model : LC013D

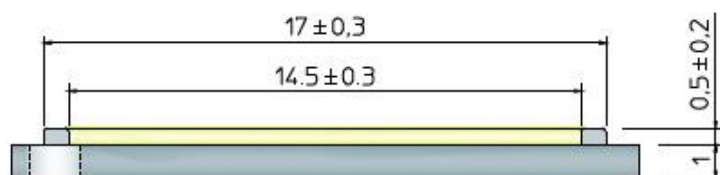
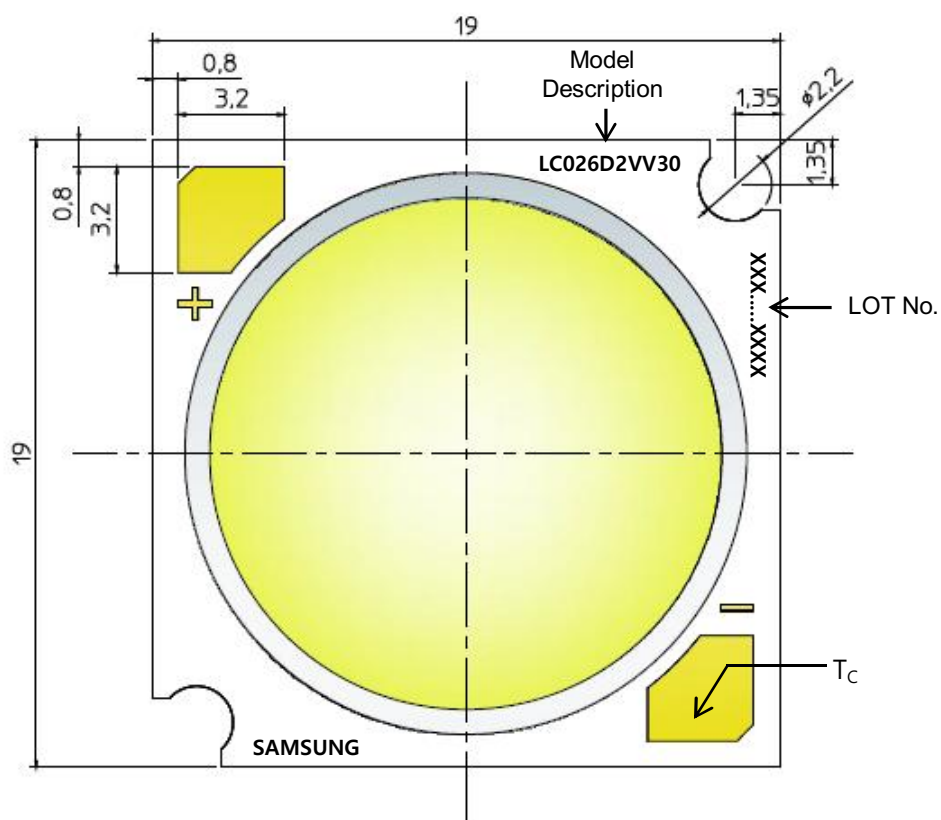


1. Unit: mm
2. Tolerance: ± 0.3 mm

Item	Dimension	Tolerance	Unit
Length	13.5	±0.15	mm
Width	13.5	±0.15	mm
Height	1.50	±0.20	mm
Light Emitting Surface (LES) Diameter	9.8	±0.30	mm

Note: Denoted product information above is only an example
(LC003D2VV30 : 3W, VIVID, 3000K)

※ Model : LC016D, LC019D, LC026D, LC033D



1. Unit: mm
2. Tolerance: ± 0.3 mm

Item	Dimension	Tolerance	Unit
Length	19.0	± 0.15	mm
Width	19.0	± 0.15	mm
Height	1.50	± 0.30	mm
Light Emitting Surface (LES) Diameter	14.5	± 0.30	mm

Note: Denoted product information above is only an example
(LC026D2VV30 : 26W, VIVID, 3000K)

5. Reliability Test Items & Conditions

a) Test Items

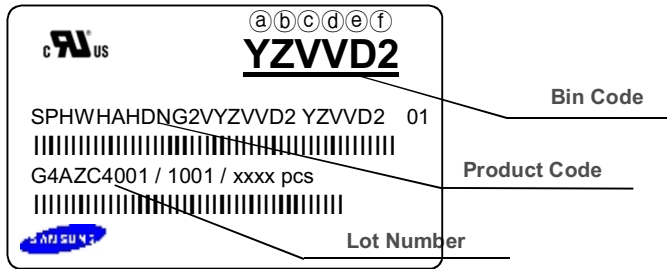
Test Item	Test Condition	Test Hour / Cycle
High Temperature Humidity Life Test	60 °C, 90 % RH,, DC Derating, I_F	1000 h
High Temperature Life Test	85 °C, DC Derating, I_F	1000 h
Low Temperature Life Test	-40 °C, DC, Derating I_F	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
Temperature Humidity Storage	60 °C, 90% RH	1000h
Temperature Cycle On/Off Test	-40 °C / 85 °C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, I_F = max	100 cycles
ESD (HBM)	R ₁ : 10 MΩ R ₂ : 1.5 kΩ C: 100 pF	5 times
ESD (MM)	R ₁ : 10 MΩ R ₂ : 0 kΩ C: 200 pF	5 times
Vibration Test	20 ~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔ max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times

b) Criteria for Judging the Damage

Item	Symbol	Test Condition ($T_c = 25\text{ °C}$)	Limit	
			Min.	Max.
Forward Voltage	V_F	I_F = Sorting Current	L.S.L. * 0.9	U.S.L. * 1.1
Luminous Flux	Φ_v	I_F = Sorting Current	L.S.L. * 0.7	U.S.L. * 1.3

6. Label Structure

a) Label Structure



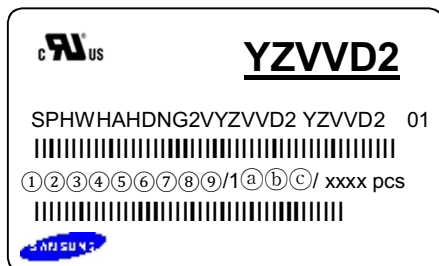
Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- ①②: Forward Voltage bin (refer to page 11)
- ③④: Chromaticity bin (refer to page 9-10)
- ⑤⑥: Luminous Flux bin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:



① ③④⑤⑥⑦⑧⑨ / 1①②③ / xxxx pcs

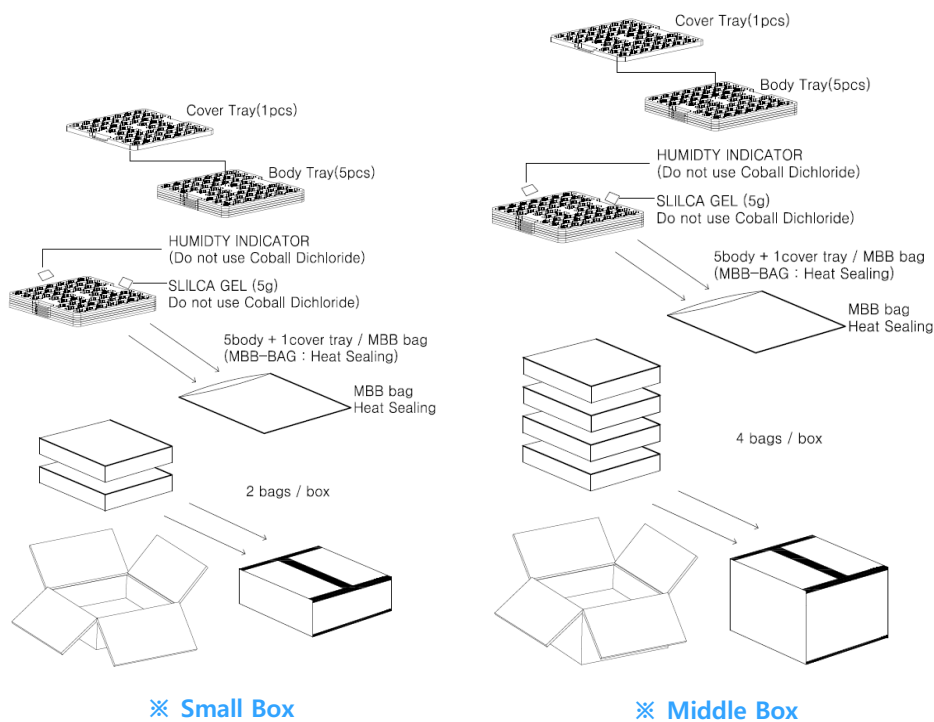
- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : 4 (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B: 2017...)
- ⑤ : Month (1~9, A, B, C)
- ⑥⑦⑧⑨ : Day (1~9, A, B~V)
- ①②③ : Product serial number (001 ~ 999)

7. Packing Structure

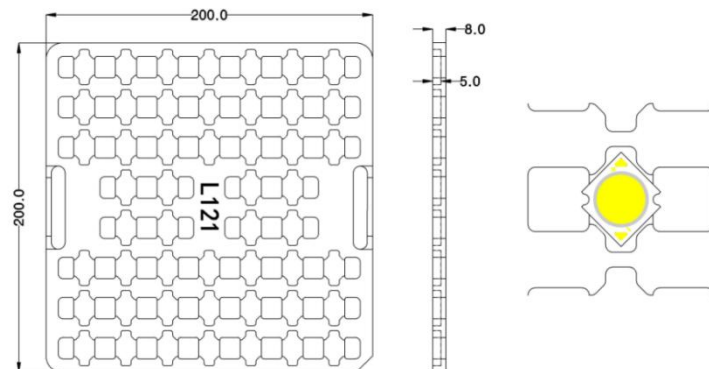
※ Model : LC013D

Packing material	Max. quantity in pcs of COB	Dimension(mm)			
		Length	Width	Height	Tolerance
Tray	50	200	200	8	1
Anti-Static Bag	250 (5 trays)	320	270	-	+/- 0.5
Outer Box (Small)	500 (2 bags)	225	225	65	5
Outer Box (Middle)	1000 (4 bags)	225	225	130	5

a) Packing Structure



b) Tray

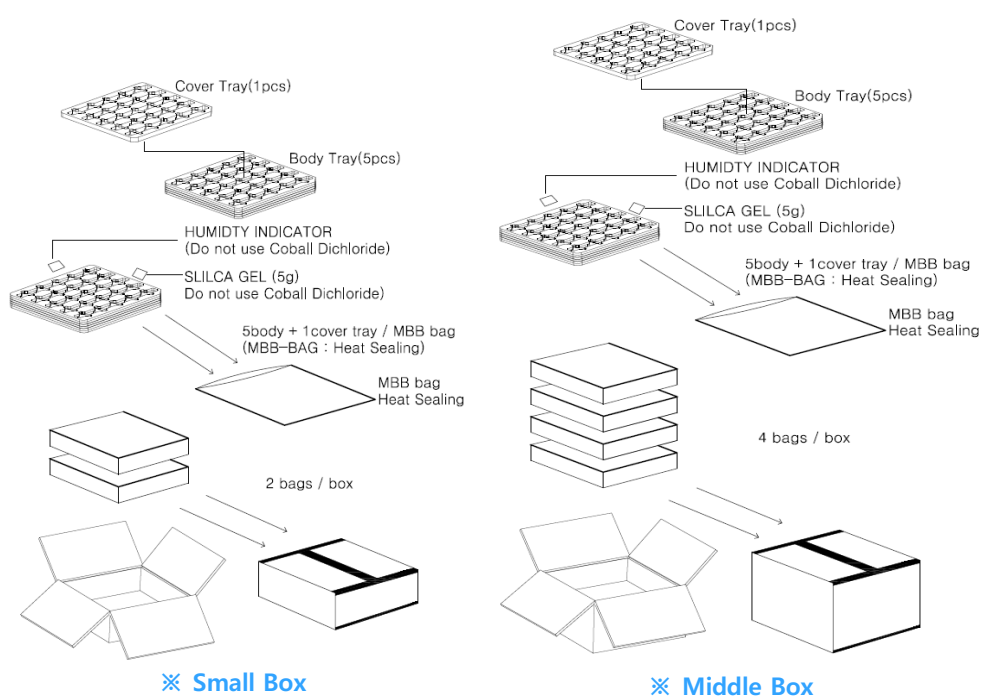


7. Packing Structure

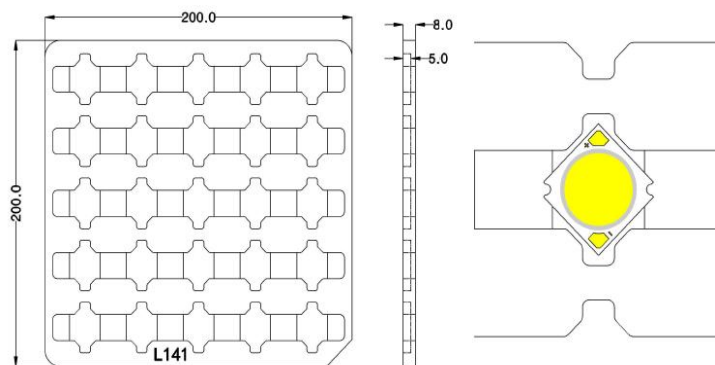
※ Model : LC016D, LC019D, LC026D, LC033D

Packing material	Max. quantity in pcs of COB	Dimension(mm)			
		Length	Width	Height	Tolerance
Tray	25	200	200	8	1
Aluminum Bag	125 (5 trays)	320	270	-	+/- 0.5
Outer Box (Small)	250 (2 bags)	225	225	65	5
Outer Box (Middle)	500 (4 bags)	225	225	130	5

a) Packing Structure

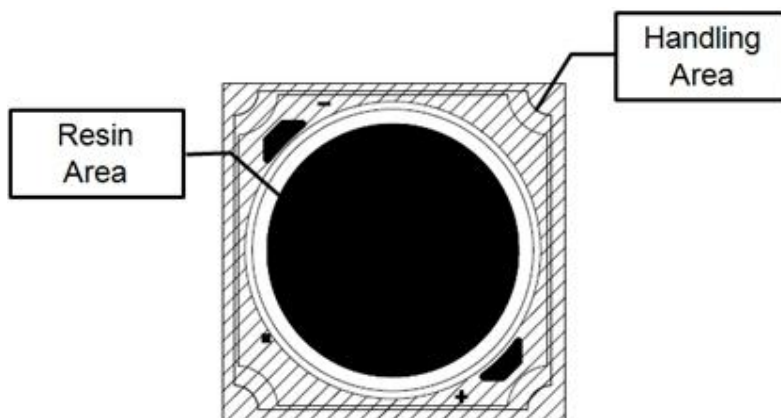


b) Tray



8. Precautions in Handling & Use

- 1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the minimum current level (I_{f_min}), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



Legal and additional information.

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